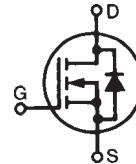


# PolarHV™ HiPerFET Power MOSFETs

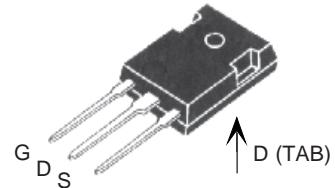
**IXFH 140N10P**  
**IXFT 140N10P**

$V_{DSS}$  = 100 V  
 $I_{D25}$  = 140 A  
 $R_{DS(on)}$  = 11 mΩ

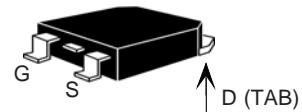
N-Channel Enhancement Mode  
Fast Intrinsic Diode; Avalanche Rated



TO-247 (IXFT)



TO-268 (IXFT)



G = Gate  
S = Source  
TAB = Drain

Symbol	Test Conditions	Maximum Ratings		
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$	100		V
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$ ; $R_{GS} = 1 \text{ M}\Omega$	100		V
$V_{GSM}$		±20		V
$I_{D25}$	$T_c = 25^\circ\text{C}$	140		A
$I_{D(RMS)}$	External lead current limit	75		A
$I_{DM}$	$T_c = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$	300		A
$I_{AR}$	$T_c = 25^\circ\text{C}$	60		A
$E_{AR}$	$T_c = 25^\circ\text{C}$	80		mJ
$E_{AS}$	$T_c = 25^\circ\text{C}$	2.5		J
$dv/dt$	$I_s \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ , $T_J \leq 150^\circ\text{C}$ , $R_G = 4 \Omega$	10		V/ns
$P_D$	$T_c = 25^\circ\text{C}$	600		W
$T_J$		-55 ... +175		°C
$T_{JM}$		175		°C
$T_{stg}$		-55 ... +150		°C
$T_L$	1.6 mm (0.062 in.) from case for 10 s	300		°C
$M_d$	Mounting torque (TO-247)	1.13/10	Nm/lb.in.	
Weight	TO-247 TO-268	6.0 5.0		g

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$V_{DSS}$	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	100		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 4.0 \text{ mA}$	3.0		5.0 V
$I_{GSS}$	$V_{GS} = \pm 20 \text{ V}_{DC}$ , $V_{DS} = 0$		±100	nA
$I_{DSS}$	$V_{DS} = V_{DSS}$ $V_{GS} = 0 \text{ V}$		25 500	μA
$R_{DS(on)}$	$V_{GS} = 10 \text{ V}$ , $I_D = 0.5 I_{D25}$ $V_{GS} = 15 \text{ V}$ , $I_D = 300 \text{ A}$ Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2 \%$	9	11	mΩ

## Features

- International standard packages
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
  - easy to drive and to protect

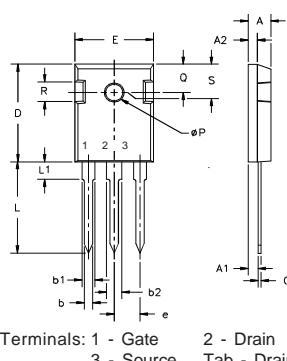
## Advantages

- Easy to mount
- Space savings
- High power density

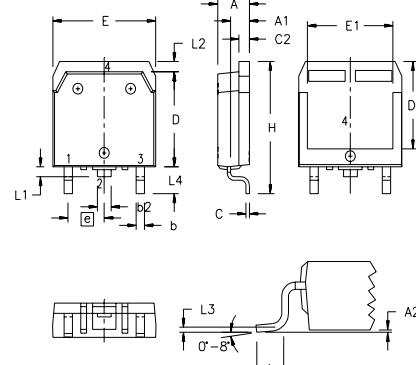
Symbol	Test Conditions	Characteristic Values		
		( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 10 \text{ V}; I_D = 0.5 I_{D25}$ , pulse test	45	65	S
$C_{iss}$ $C_{oss}$ $C_{rss}$	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	4700	pF	
		1850	pF	
		600	pF	
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 60 \text{ A}$ $R_G = 4 \Omega$ (External)	35	ns	
		50	ns	
		85	ns	
		26	ns	
$Q_{g(on)}$ $Q_{gs}$ $Q_{gd}$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 0.5 I_{D25}$	155	nC	
		33	nC	
		85	nC	
$R_{thJC}$			0.25 K/W	
$R_{thCK}$	(TO-247)	0.21	K/W	

**Source-Drain Diode**
**Characteristic Values**
 $(T_J = 25^\circ\text{C}, \text{unless otherwise specified})$ 

Symbol	Test Conditions	Min.	typ.	Max.
$I_s$	$V_{GS} = 0 \text{ V}$			140 A
$I_{SM}$	Repetitive			300 A
$V_{SD}$	$I_F = I_s, V_{GS} = 0 \text{ V},$ Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2 \%$			1.5 V
$t_{rr}$ $Q_{RM}$	$I_F = 25 \text{ A}$ $-di/dt = 100 \text{ A}/\mu\text{s}$	120	ns	
	$V_R = 50 \text{ V}$	0.8	$\mu\text{C}$	
		6	A	

**TO-247 AD Outline**


Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.7	5.3	.185	.209
A <sub>1</sub>	2.2	2.54	.087	.102
A <sub>2</sub>	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b <sub>1</sub>	1.65	2.13	.065	.084
b <sub>2</sub>	2.87	3.12	.113	.123
C	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L <sub>1</sub>		4.50		.177
ØP	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC

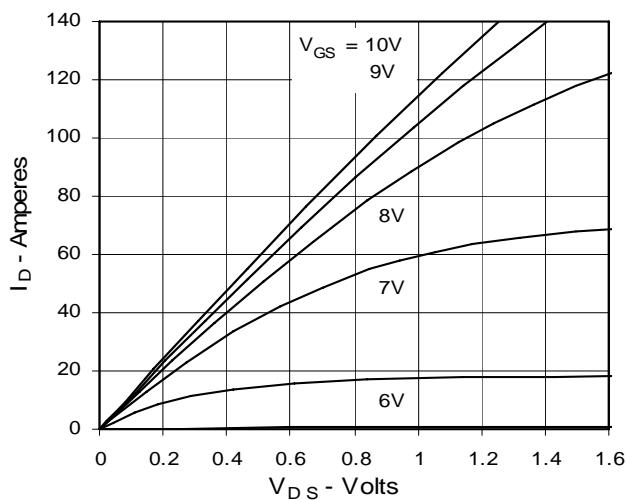
**TO-268 Outline**


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.193	.201	4.90	5.10
A1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
b2	.075	.083	1.90	2.10
C	.016	.026	0.40	0.65
C2	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.488	.500	12.40	12.70
E	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
e	.215	BSC	5.45	BSC
H	.736	.752	18.70	19.10
L	.094	.106	2.40	2.70
L1	.047	.055	1.20	1.40
L2	.039	.045	1.00	1.15
L3	.010	BSC	0.25	BSC
L4	.150	.161	3.80	4.10

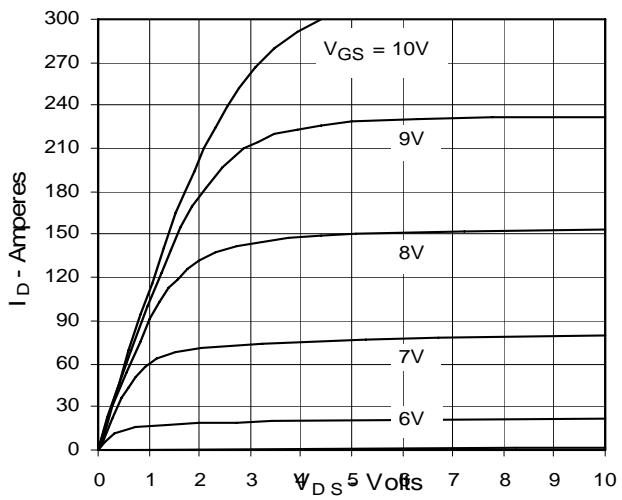
IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more U.S. patents: 4,850,072, 4,931,844, 5,034,796, 5,063,307, 5,237,481, 5,381,025, 6,404,065B1, 6,162,665, 6,534,343, 6,583,505, 6,306,728B1, 6,259,123B1, 6,306,728B1, 6,683,344.

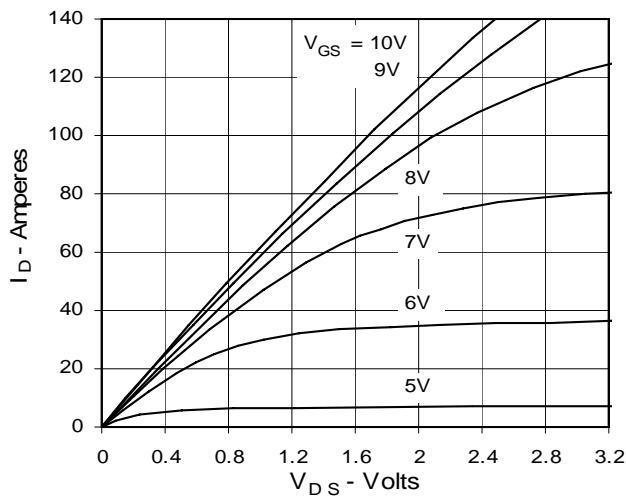
**Fig. 1. Output Characteristics  
@ 25°C**



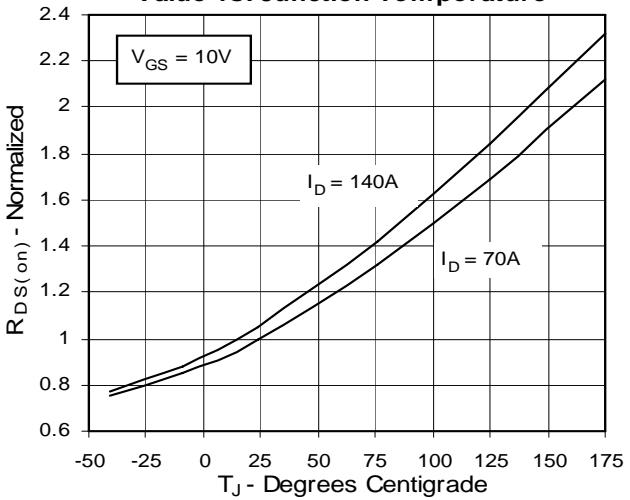
**Fig. 2. Extended Output Characteristics  
@ 25°C**



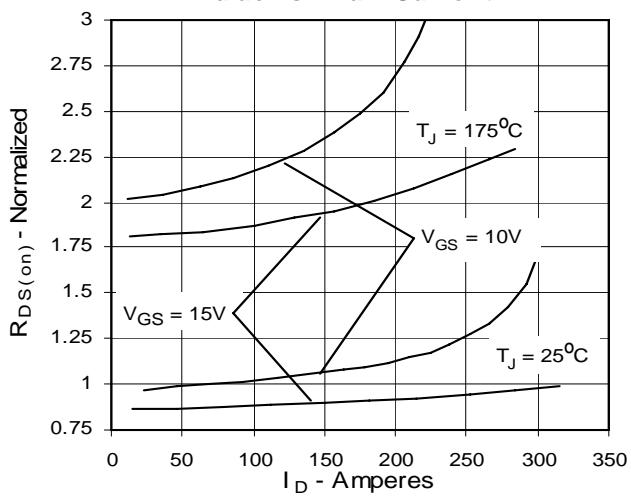
**Fig. 3. Output Characteristics  
@ 150°C**



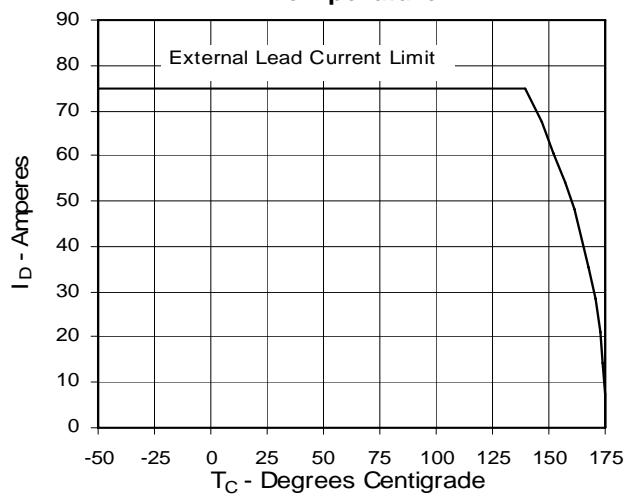
**Fig. 4.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs. Junction Temperature**

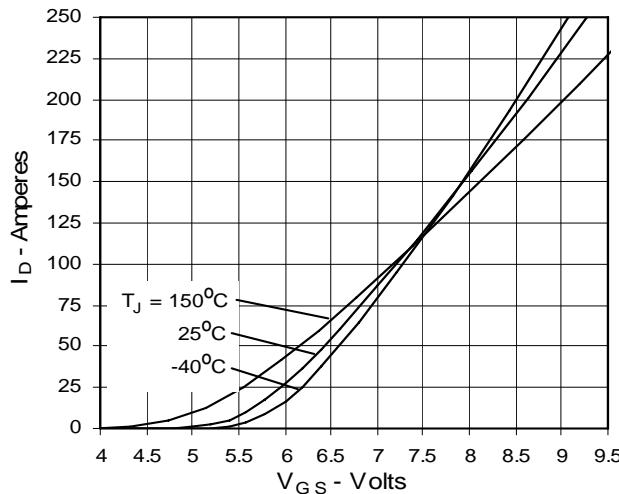
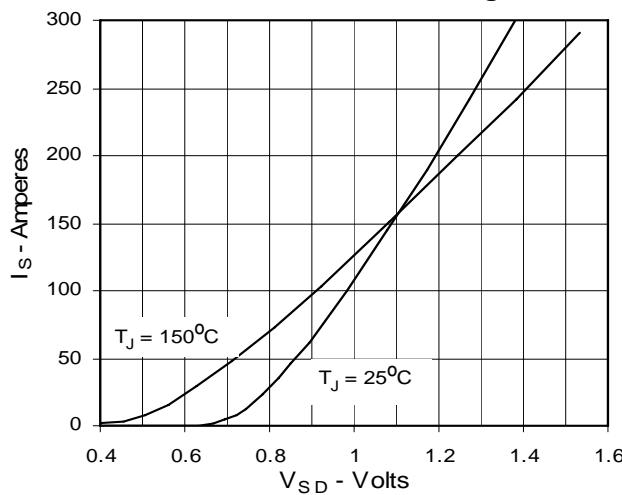
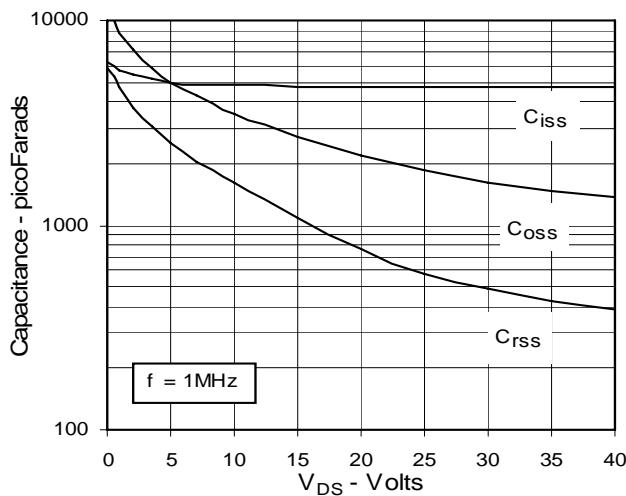
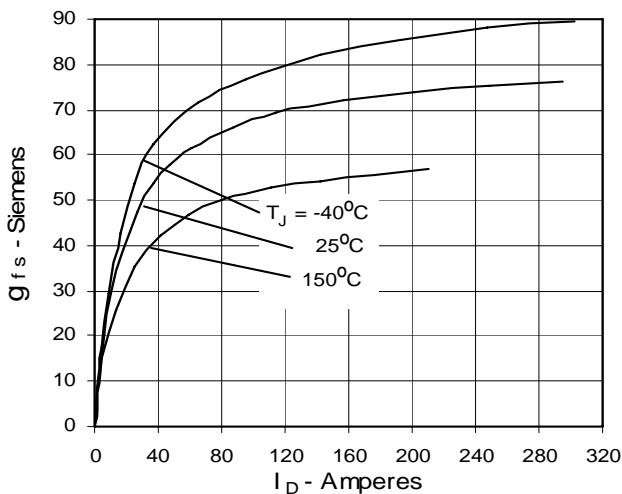
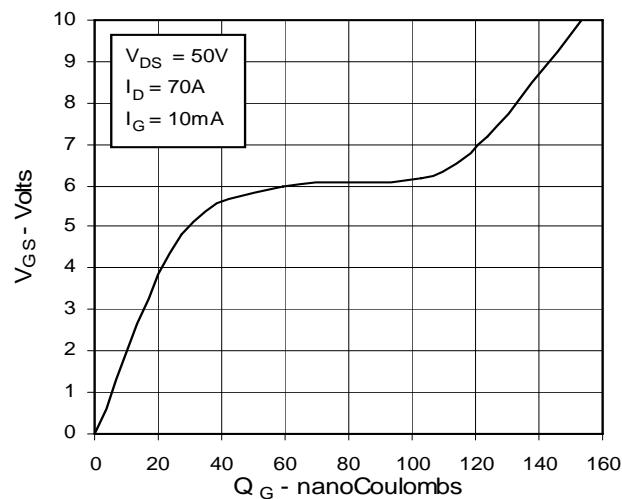
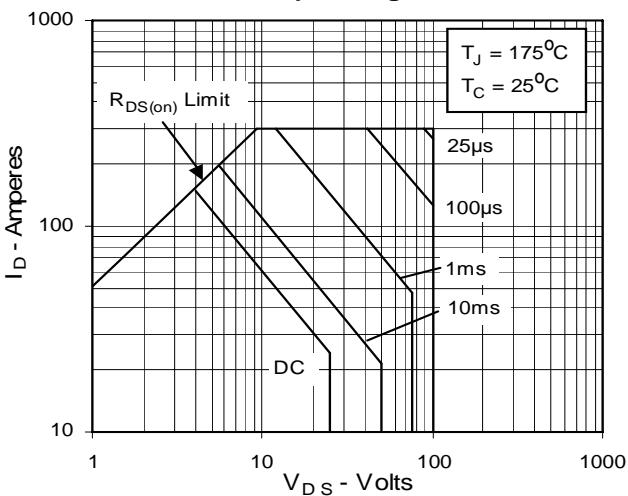


**Fig. 5.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs. Drain Current**



**Fig. 6. Drain Current vs. Case Temperature**



**Fig. 7. Input Admittance**

**Fig. 9. Source Current vs. Source-To-Drain Voltage**

**Fig. 11. Capacitance**

**Fig. 8. Transconductance**

**Fig. 10. Gate Charge**

**Fig. 12. Forward-Bias Safe Operating Area**


IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

4,835,592	4,881,106	5,017,508	5,063,307	5,237,481	5,381,025	5,486,715	6,404,065B1	6,162,665	6,534,343	6,683,344
4,850,072	4,931,844	5,034,796	5,049,961	5,187,117	6,306,728B1	6,259,123B1	6,306,728B1	6,683,505		

**Fig. 13. Maximum Transient Thermal Resistance**